Renesas - DF2128FA20V Datasheet





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Details

Product Status	Obsolete
Core Processor	H8S/2000
Core Size	32-Bit
Speed	20MHz
Connectivity	SCI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	43
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b SAR
Oscillator Type	Internal
Operating Temperature	-20°C ~ 75°C (TA)
Mounting Type	Surface Mount
Package / Case	64-BQFP
Supplier Device Package	64-QFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/df2128fa20v

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2.4 Register Configuration

2.4.1 Overview

The CPU has the internal registers shown in figure 2.7. There are two types of registers: general registers and control registers.



Figure 2.7 CPU Registers

							Ad	dressi	ng Moo	des					
Function	Instruction	xx#	Rn	@ERn	@(d:16,ERn)	@(d:32,ERn)	@-ERn/@ERn+	@aa:8	@aa:16	@aa:24	@aa:32	@(d:8,PC)	@(d:16,PC)	@ @aa:8	I
System	TRAPA	—	_	_	_	_	_	—	_	_	—	_	_	—	0
control	RTE	_	_	_	_	_	_	_	_	_	_	_	_	_	0
	SLEEP	_	_	_	_	_	_	_	_	_	_	_	_	_	0
	LDC	В	В	W	W	w	W	_	w	—	W	—	_	_	_
	STC	_	В	W	W	W	W	_	w	_	W	_	_	_	_
	ANDC, ORC, XORC	В	_	_	—	—	_	—	_	_	—	_	_	_	—
	NOP	_	_	_	_	_	_	_	_	_	_	_	_	_	0
Block data t	ransfer	_	_	_	_	_	_	_	_	_	_	_	_	_	BW

Legend:

B: Byte

W: Word

L: Longword

Vector Address*1 Normal Mode **Exception Source** Vector Number Advanced Mode Reset 0 H'0000 to H'0001 H'0000 to H'0003 Reserved for system use 1 H'0002 to H'0003 H'0004 to H'0007 2 H'0004 to H'0005 H'0008 to H'000B 3 H'0006 to H'0007 H'000C to H'000F 4 H'0008 to H'0009 H'0010 to H'0013 5 H'000A to H'000B H'0014 to H'0017 **Direct transition** 6 H'000C to H'000D H'0018 to H'001B 7 External interrupt NMI H'000E to H'000F H'001C to H'001F Trap instruction (4 sources) 8 H'0010 to H'0011 H'0020 to H'0023 9 H'0012 to H'0013 H'0024 to H'0027 10 H'0014 to H'0015 H'0028 to H'002B 11 H'0016 to H'0017 H'002C to H'002F Reserved for system use 12 H'0018 to H'0019 H'0030 to H'0033 13 H'001A to H'001B H'0034 to H'0037 14 H'001C to H'001D H'0038 to H'003B 15 H'001E to H'001F H'003C to H'003F External interrupt IRQ0 16 H'0020 to H'0021 H'0040 to H'0043 IRQ1 17 H'0022 to H'0023 H'0044 to H'0047 IRQ2 18 H'0024 to H'0025 H'0048 to H'004B H'0026 to H'0027 Reserved H'004C to H'004F 19 20 H'0028 to H'0029 H'0050 to H'0053 21 H'002A to H'002B H'0054 to H'0057 22 H'002C to H'002D H'0058 to H'005B 23 H'002E to H'002F H'005C to H'005F

Table 4.2 **Exception Vector Table**

Notes: 1. Lower 16 bits of the address.

24

103

Internal interrupt*2

2. For details on internal interrupt vectors, see section 5.3.3, Interrupt Exception Vector Table.

H'0030 to H'0031

H'00CE to H'00CF

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H'0060 to H'0063

H'019C to H'019F

8.3.2 Register Configuration

Table 8.5 shows the port 2 register configuration.

Table 8.5Port 2 Registers

Name	Abbreviation	R/W	Initial Value	Address*
Port 2 data direction register	P2DDR	W	H'00	H'FFB1
Port 2 data register	P2DR	R/W	H'00	H'FFB3
Port 2 MOS pull-up control register	P2PCR	R/W	H'00	H'FFAD

Note: * Lower 16 bits of the address.

Port 2 Data Direction Register (P2DDR)

Bit	7	6	5	4	3	2	1	0
	P27DDR	P26DDR	P25DDR	P24DDR	P23DDR	P22DDR	P21DDR	P20DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

P2DDR is an 8-bit write-only register, the individual bits of which specify input or output for the pins of port 2. P2DDR cannot be read; if it is, an undefined value will be returned.

P2DDR is initialized to H'00 by a reset and in hardware standby mode. It retains its prior state in software standby mode. The address output pins maintain their output state in a transition to software standby mode.

• Mode 1

The corresponding port 2 pins are address outputs, regardless of the P2DDR setting. In hardware standby mode, the address outputs go to the high-impedance state.

• Modes 2 and 3 (EXPE = 1)

The corresponding port 2 pins are address outputs or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0. P27 to P24 are switched from address outputs to output ports by setting the IOSE bit to 1.

P27 to P23 can be used as an on-chip supporting module output pin regardless of the P2DDR setting, but to ensure normal access to external space, P27 should not be set as an on-chip supporting module output pin when port 2 pins are used as address output pins.

• Modes 2 and 3 (EXPE = 0)

The corresponding port 2 pins are output ports or PWM outputs when P2DDR bits are set to 1, and input ports when cleared to 0.

Section 9 8-Bit PWM Timers [H8S/2128 Series]

9.1 Overview

The H8/2128 Series has an on-chip pulse width modulation (PWM) timer module with sixteen outputs. Sixteen output waveforms are generated from a common time base, enabling PWM output with a high carrier frequency to be produced using pulse division. The PWM timer module has sixteen 8-bit PWM data registers (PWDRs), and an output pulse with a duty cycle of 0 to 100% can be obtained as specified by PWDR and the port data register (P1DR or P2DR).

9.1.1 Features

The PWM timer module has the following features.

- Operable at a maximum carrier frequency of 1.25 MHz using pulse division (at 20 MHz operation)
- Duty cycles from 0 to 100% with 1/256 resolution (100% duty realized by port output)
- Direct or inverted PWM output, and PWM output enable/disable control

11.3.7 Setting of FRC Overflow Flag (OVF)

The FRC overflow flag (OVF) is set to 1 when FRC overflows (changes from H'FFFF to H'0000). Figure 11.13 shows the timing of this operation.



Figure 11.13 Setting of Overflow Flag (OVF)

11.3.8 Automatic Addition of OCRA and OCRAR/OCRAF

When the OCRAMS bit in TOCR is set to 1, the contents of OCRAR and OCRAF are automatically added to OCRA alternately, and when an OCRA compare-match occurs a write to OCRA is performed. The OCRA write timing is shown in figure 11.14.



Figure 11.14 OCRA Automatic Addition Timing

11.3.9 ICRD and OCRDM Mask Signal Generation

When the ICRDMS bit in TOCR is set to 1 and the contents of OCRDM are other than H'0000, a signal that masks the ICRD input capture function is generated.

The mask signal is set by the input capture signal. The mask signal setting timing is shown in figure 11.15.

The mask signal is cleared by the sum of the ICRD contents and twice the OCRDM contents, and an FRC compare-match. The mask signal clearing timing is shown in figure 11.16.



Figure 11.15 Input Capture Mask Signal Setting Timing



Figure 11.16 Input Capture Mask Signal Clearing Timing

12.3 Operation

12.3.1 TCNT Incrementation Timing

TCNT is incremented by input clock pulses (either internal or external).

Internal Clock: An internal clock created by dividing the system clock (ø) can be selected by setting bits CKS2 to CKS0 in TCR. Figure 12.2 shows the count timing.



Figure 12.2 Count Timing for Internal Clock Input

External Clock: Three incrementation methods can be selected by setting bits CKS2 to CKS0 in TCR: at the rising edge, the falling edge, and both rising and falling edges.

Note that the external clock pulse width must be at least 1.5 states for incrementation at a single edge, and at least 2.5 states for incrementation at both edges. The counter will not increment correctly if the pulse width is less than these values.

Figure 12.3 shows the timing of incrementation at both edges of an external clock signal.

14.1.2 Block Diagram



Figures 14.1 (a) and (b) show block diagrams of WDT0 and WDT1.

Figure 14.1 (a) Block Diagram of WDT0

15.2 Register Descriptions

15.2.1 Receive Shift Register (RSR)



RSR is a register used to receive serial data.

The SCI sets serial data input from the RxD pin in RSR in the order received, starting with the LSB (bit 0), and converts it to parallel data. When one byte of data has been received, it is transferred to RDR automatically.

RSR cannot be directly read or written to by the CPU.

15.2.2 Receive Data Register (RDR)



RDR is a register that stores received serial data.

When the SCI has received one byte of serial data, it transfers the received serial data from RSR to RDR where it is stored, and completes the receive operation. After this, RSR is receive-enabled.

Since RSR and RDR function as a double buffer in this way, continuous receive operations can be performed.

RDR is a read-only register, and cannot be written to by the CPU.

RDR is initialized to H'00 by a reset, and in standby mode, watch mode, subactive mode, subsleep mode, and module stop mode.





16.1.3 Input/Output Pins

Table 16.1 summarizes the input/output pins used by the I²C bus interface.

Table 16.1	I ² C Bus	Interface	Pins
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Channel	Name	Abbreviation	I/O	Function
0	Serial clock	SCL0	I/O	IIC0 serial clock input/output
	Serial data	SDA0	I/O	IIC0 serial data input/output
	Formatless serial clock	VSYNCI	Input	IIC0 formatless serial clock input
1	Serial clock	SCL1	I/O	IIC1 serial clock input/output
	Serial data	SDA1	I/O	IIC1 serial data input/output

Note: In the text, the channel subscript is omitted, and only SCL and SDA are used.

17.4 Operation

The A/D converter operates by successive approximations with 10-bit resolution. It has two operating modes: single mode and scan mode.

17.4.1 Single Mode (SCAN = 0)

Single mode is selected when A/D conversion is to be performed on a single channel only. A/D conversion is started when the ADST bit is set to 1 by software, or by external trigger input. The ADST bit remains set to 1 during A/D conversion, and is automatically cleared to 0 when conversion ends.

On completion of conversion, the ADF flag is set to 1. If the ADIE bit is set to 1 at this time, an ADI interrupt request is generated. The ADF flag is cleared by writing 0 after reading ADCSR.

When the operating mode or analog input channel must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the operating mode or input channel is changed.

Typical operations when channel 1 (AN1) is selected in single mode are described next. Figure 17.3 shows a timing diagram for this example.

- 1. Single mode is selected (SCAN = 0), input channel AN1 is selected (CH1 = 0, CH0 = 1), the A/D interrupt is enabled (ADIE = 1), and A/D conversion is started (ADST = 1).
- 2. When A/D conversion is completed, the result is transferred to ADDRB. At the same time the ADF flag is set to 1, the ADST bit is cleared to 0, and the A/D converter becomes idle.
- 3. Since ADF = 1 and ADIE = 1, an ADI interrupt is requested.
- 4. The A/D interrupt handling routine starts.
- 5. The routine reads ADCSR, then writes 0 to the ADF flag.
- 6. The routine reads and processes the conversion result (ADDRB).
- 7. Execution of the A/D interrupt handling routine ends. After that, if the ADST bit is set to 1, A/D conversion starts again and steps 2 to 7 are repeated.

Instruc-	Macmonio	i							Instructio	n Format				
tion		Size	1st E	3yte	2nd E	3yte	3rd Byte	4th Byte	5th Byte	6th Byte	7th Byte	8th Byte	9th Byte	10th Byte
ROTR	ROTR.B Rd	ш	-	е	8	rd								
	ROTR.B #2, Rd	۵	-	с	ပ	p								
	ROTR.W Rd	N	-	3	6	rd								
	ROTR.W #2, Rd	×	-	с	۵	p								
	ROTR.L ERd	-	-	3	в	0: erd								
	ROTR.L #2, ERd	_	-	e	ш	0 erd								
ROTXL	ROTXL.B.Rd	۵	-	2	0	p								
	ROTXL.B #2, Rd	۵	-	2	4	p								
	ROTXL.W Rd	≥	-	2	-	p								
	ROTXL.W #2, Rd	≥	-	2	5	p								
	ROTXL.L ERd	_	-	2	e	0 erd								
	ROTXL.L #2, ERd	_	-	2	7	0: erd								
ROTXR	ROTXR.B Rd	в	-	з	0	rd								
	ROTXR.B #2, Rd	۵	-	с	4	p								
	ROTXR.W Rd	X	-	3	-	rd								
	ROTXR.W #2, Rd	≥	-	e	5	p								
	ROTXR.L ERd	_	-	с	e	0: erd								
	ROTXR.L #2, ERd	Ч	-	ю	7	0 erd								
RTE	RTE	Ι	5	9	7	0								
RTS	RTS	Ι	2	4	7	0								
SHAL	SHAL.B Rd	В	-	0	8	rd								
	SHAL.B #2, Rd	в	-	0	υ	p								
	SHAL.W Rd	≥	-	0	6	p								
	SHAL.W #2, Rd	Ν	-	0	۵	rd								
	SHAL.L ERd	_	~	0	۵	0 erd								
	SHAL.L #2, ERd	_	-	0	ш	0: erd								

Instruction	1	2	3	4	5	6	7	8	9
MOV.B @(d:32,ERs),Rd	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:B EA				
MOV.B @ERs+,Rd	R:W NEXT	Internal operation, 1 state	R:B EA						
MOV.B @aa:8,Rd	R:W NEXT	R:B EA							
MOV.B @aa:16,Rd	R:W 2nd	R:W NEXT	R:B EA						
MOV.B @aa:32,Rd	R:W 2nd	R:W 3rd	R:W NEXT	R:B EA					
MOV.B Rs,@ERd	R:W NEXT	W:B EA							
MOV.B Rs, @(d:16,ERd)	R:W 2nd	R:W NEXT	W:B EA						
MOV.B Rs, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:B EA				
MOV.B Rs,@-ERd	R:W NEXT	Internal operation, 1 state	W:B EA						
MOV.B Rs,@aa:8	R:W NEXT	W:B EA							
MOV.B Rs,@aa:16	R:W 2nd	R:W NEXT	W:B EA						
MOV.B Rs,@aa:32	R:W 2nd	R:W 3rd	R:W NEXT	W:B EA					
MOV.W #xx:16,Rd	R:W 2nd	R:W NEXT							
MOV.W Rs,Rd	R:W NEXT								
MOV.W @ERs,Rd	R:W NEXT	R:W EA							
MOV.W @(d:16,ERs),Rd	R:W 2nd	R:W NEXT	R:W EA						
MOV.W @(d:32,ERs),Rd	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	R:W EA				
MOV.W @ERs+,Rd	R:W NEXT	Internal operation, 1 state	R:W EA						
MOV.W @aa:16,Rd	R:W 2nd	R:W NEXT	R:W EA						
MOV.W @aa:32,Rd	R:W 2nd	R:W 3rd	R:W NEXT	R:B EA					
MOV.W Rs,@ERd	R:W NEXT	W:W EA							
MOV.W Rs, @(d:16,ERd)	R:W 2nd	R:W NEXT	W:W EA						
MOV.W Rs, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
MOV.W Rs,@-ERd	R:W NEXT	Internal operation, 1 state	W:W EA						
MOV.W Rs,@aa:16	R:W 2nd	R:W NEXT	W:W EA						
MOV.W Rs,@aa:32	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					

Instruction	1	2	3	4	5	6	7	8	9
SLEEP	R:W NEXT	Internal operation :M							
STC CCR,Rd	R:W NEXT								
STC EXR,Rd	R:W NEXT								
STC CCR,@ERd	R:W 2nd	R:W NEXT	W:W EA						
STC EXR,@ERd	R:W 2nd	R:W NEXT	W:W EA		-				
STC CCR, @(d:16,ERd)	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC EXR, @(d:16,ERd)	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC CCR, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	W:W EA			
STC EXR, @(d:32,ERd)	R:W 2nd	R:W 3rd	R:W 4th	R:W 5th	R:W NEXT	W:W EA			
STC CCR,@-ERd	R:W 2nd	R:W NEXT	Internal operation, 1 state	W:W EA					
STC EXR,@-ERd	R:W 2nd	R:W NEXT	Internal operation, 1 state	W:W EA					
STC CCR,@aa:16	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC EXR,@aa:16	R:W 2nd	R:W 3rd	R:W NEXT	W:W EA					
STC CCR,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
STC EXR,@aa:32	R:W 2nd	R:W 3rd	R:W 4th	R:W NEXT	W:W EA				
STM.L (ERn-ERn+1), @-SP* ⁹	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STM.L (ERn-ERn+2), @-SP* ⁹	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STM.L (ERn-ERn+3), @-SP* ⁹	R:W 2nd	R:W:M NEXT	Internal operation, 1 state	W:W:M Stack (H) * ³	W:W Stack (L) * ³				
STMAC MACH, ERd	Cannot be	used in the l	H8S/2128 S	eries and H8	3S/2124 Ser	ies			
STMAC MACL,ERd				•			•		
SUB.B Rs,Rd	R:W NEXT								
SUB.W #xx:16,Rd	R:W 2nd	R:W NEXT							
SUB.W Rs,Rd	R:W NEXT								
SUB.L #xx:32,ERd	R:W 2nd	R:W 3rd	R:W NEXT						
SUB.L ERs,ERd	R:W NEXT								



For details, see section 11.2.3, Input Capture Registers A to D (ICRA to ICRD).)

Renesas

DACR—PWM (D/A) Control Register

H'FFA0



0	PWM (D/A) in user state, normal operation
1	PWM (D/A) in test state, correct conversion results unobtainable

MDCR—Mode Control Register

H'FFC5

System



Note: * Determined by pins MD1 and MD0.

PWSL-PWM	Register	Select			H'FFD6						
Bit	7	6	5	4	;	3		2	1	0	
	PWCKE	PWCKS	_		R	S3		RS2	RS1	RS0	
Initial value	0	0	1	1	. (0		0	0	0	
Read/Write	R/W	R/W	—	—	R	/W		R/W	R/W	R/W	
					Reg	ister 0	Se 0	lect –	PWDR0 sel	ected	
								1 F	PWDR1 sel	ected	
								0 F	PWDR2 sel	ected	
								1 F	PWDR3 sel	ected	
					1		0	0 F	PWDR4 sel	ected	
								1 F	PWDR5 sel	ected	
							1	0 F	PWDR6 sel	ected	
								1 F	PWDR7 sel	ected	
					1	0	0	0 F	PWDR8 sel	ected	
								1 F	PWDR9 sel	ected	
							1	0 F	PWDR10 se	elected	
								1 F	PWDR11 se	elected	
						1	0	0 F	PWDR12 se	elected	
								1 F	PWDR13 se	elected	
							1	0 F	PWDR14 se	elected	
								1 F	PWDR15 se	lected	

PWM clock enable, PWM clock select

PV	/SL	PC	SR	
Bit 7	Bit 6	Bit 2	Bit 1	Description
PWCKE	PWCKS	PWCKB	PWCKA	
0	—	—		Clock input disabled
1	0			ø (system clock) selected
	1	0	0	ø/2 selected
			1	ø/4 selected
		1	0	ø/8 selected
			1	ø/16 selected

Figures G.1, G.2 and G.3 show the package dimensions of the H8S/2128 Series and H8S/2124 Series.



Figure G.1 Package Dimensions (DP-64S)